502887032 07/10/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUNG SUN CHOI	07/07/2014
KYUNG NAM KIM	07/07/2014
KYUNG HO CHOI	07/07/2014
YEONG JIN CHOI	07/07/2014

RECEIVING PARTY DATA

Name:	AMOREPACIFIC CORPORATION	
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14371658

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SIGNATURE:	/James J. Merrick/	
DATE SIGNED:	07/10/2014	

Total Attachments: 2 source=77V0340#page1.tif source=77V0340#page2.tif

PATENT 502887032 REEL: 033289 FRAME: 0128

ASSIGNMENT

WHEREAS WE, CHOI, Jung Sun of AMOREPACIFIC R&D CENTER, 314-1, Bora-dong, Giheung-gu, Yongin-si, Gyeonggi-do 446-729, Republic of Korea; KIM, Kyung Nam of AMOREPACIFIC R&D CENTER, 314-1, Bora-dong, Giheung-gu, Yongin-si, Gyeonggi-do 446-729, Republic of Korea; CHOI, Kyung Ho of AMOREPACIFIC R&D CENTER, 314-1, Bora-dong, Giheung-gu, Yongin-si, Gyeonggi-do 446-729, Republic of Korea and CHOI, Yeong Jin of AMOREPACIFIC R&D CENTER, 314-1, Bora-dong, Giheung-gu, Yongin-si, Gyeonggi-do 446-729, Republic of Korea (hereinafter collectively referred to as the "ASSIGNORS"), have invented certain new and useful improvements in:

COSMETIC COMPOSITION CARRIER CONTAINING URETHANE FOAM LAYER'S TRUCTURE

(hereinafter referred to as the "INVENTION") which is the national stage application of International Application No. <u>PCT/KR2013/000229</u>, filed on <u>January 11, 2013</u>; and for which we are about to file an application for a United States Patent (hereinafter collectively referred to as the "APPLICATIONS");

AND WHEREAS, AMOREPACIFIC CORPORATION (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Republic of Korea, having a place of business at 181, 2-ga, Hangang-ro, Yongsan-gu, Seoul 140-777, Republic of Korea, is desirous of acquiring an interest in any and all countries, in and to the INVENTION, the APPLICATIONS, and any and all Patents to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, we, the ASSIGNORS, have assigned and transferred, and hereby assign and transfer unto ASSIGNEE, the entire right, title and interest in and to the INVENTION, the APPLICATIONS, and any and all Patents that may be issued therefrom, in any and all countries, including any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to ASSIGNEE; and we do hereby agree that we will execute all papers necessary in connection with any and all patent applications when called upon to do so by ASSIGNEE, its successors or assigns, and that we will, at the cost and expense of ASSIGNEE, fully assist and cooperate in all matters in connection with any and all patent applications and Patents issuing thereon.

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PATENT REEL: 033289 FRAME: 0129 The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the APPLICATIONS or any Patents issuing thereon.

Date: July 1. 2014

CHOI, Jung Sun

Date: July 2. 2014

KIM, Kyung Nam

Date: July 7, 2014

CHOI, Kyung Ho

Date: July 1, 2014

CHOI, Yeong Jin